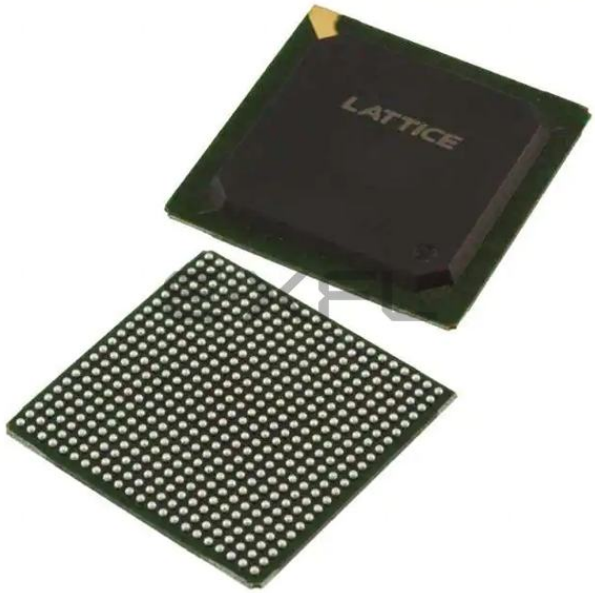
Lattice Semiconductor Corporation - LFEC20E-5F484C Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	19700
Total RAM Bits	434176
Number of I/O	360
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec20e-5f484c

Figure 2-1. Simplified Block Diagram, LatticeEC Device (Top Level)

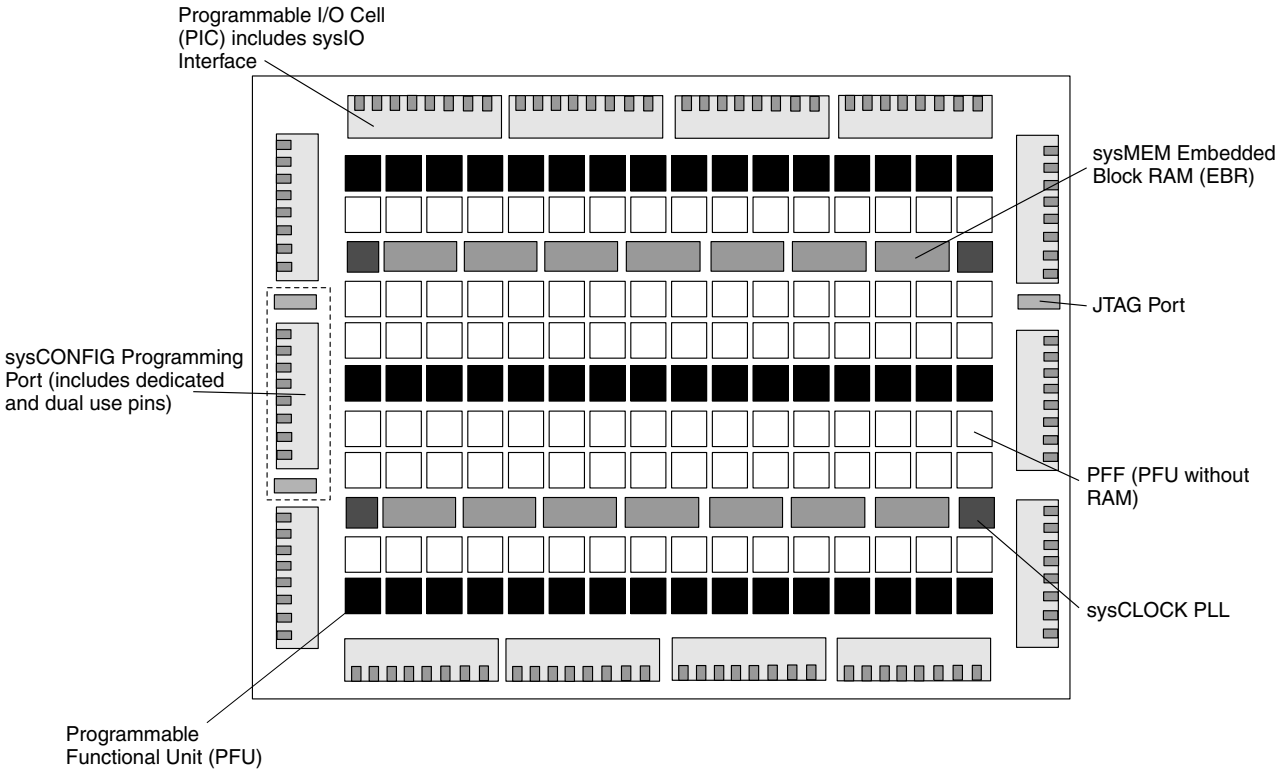
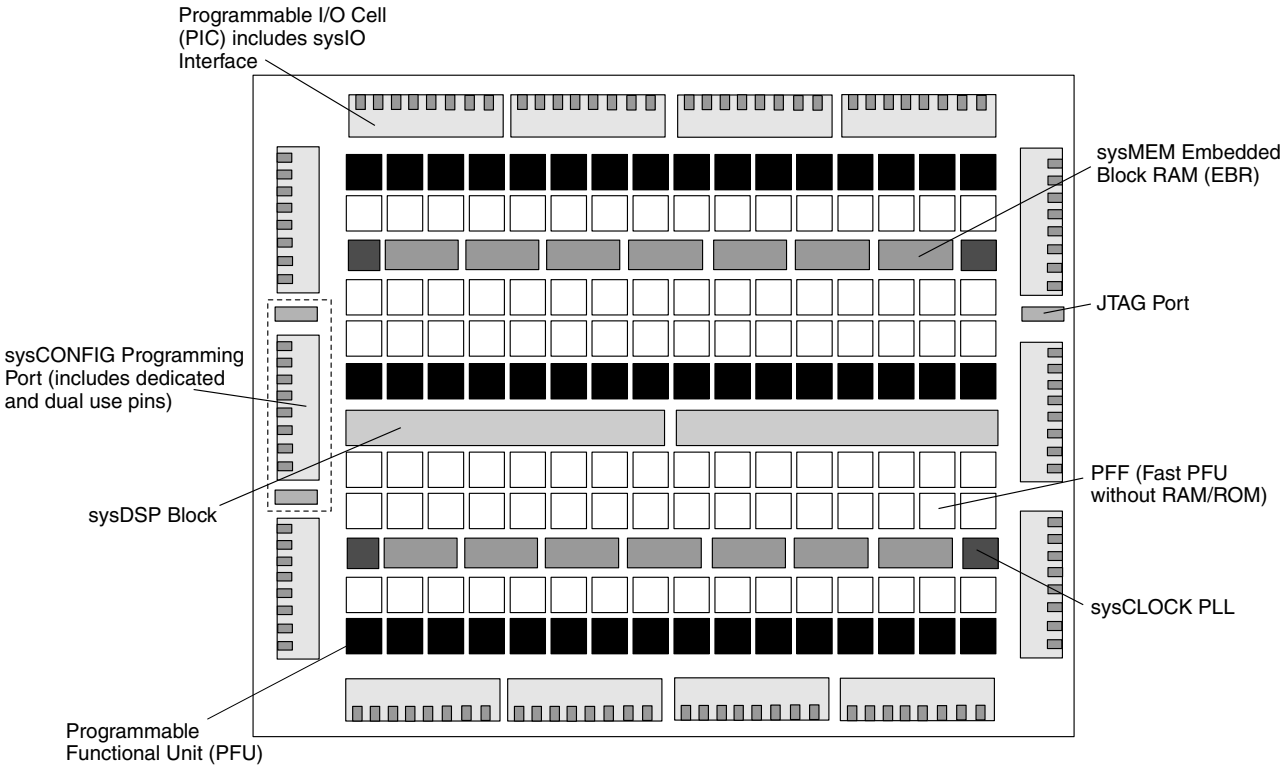


Figure 2-2. Simplified Block Diagram, LatticeECP-DSP Device (Top Level)



Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

Table 2-8. An Example of Sign Extension

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9-Bits	Two's Complement Signed 18-bits
+5	0101	000000101	000000000000000101	0101	000000101	000000000000000101
-6	0110	000000110	000000000000000110	1010	111111010	111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number then accumulator roll over is said to occur and overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator "roll-over" is said to have occurred and an overflow signal is indicated. Note when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-23.

Figure 2-23. Accumulator Overflow/Underflow Conditions

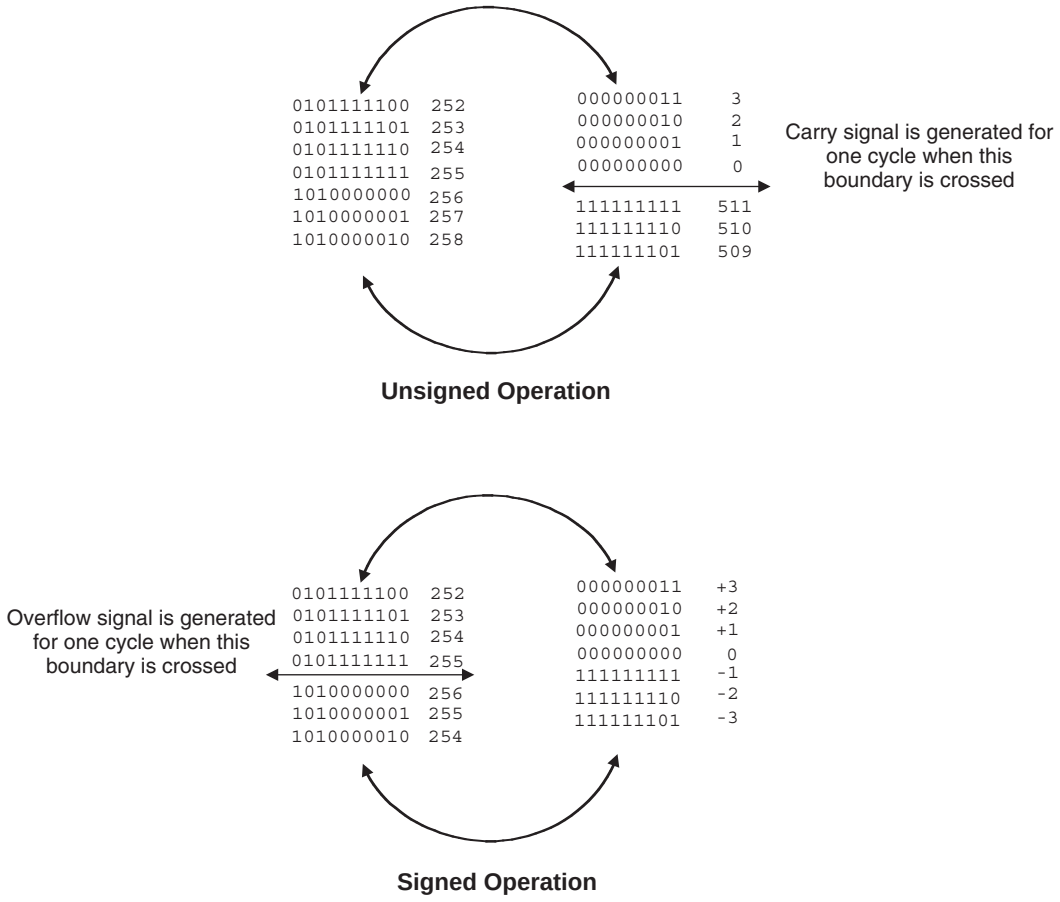


Figure 2-27. Input Register DDR Waveforms

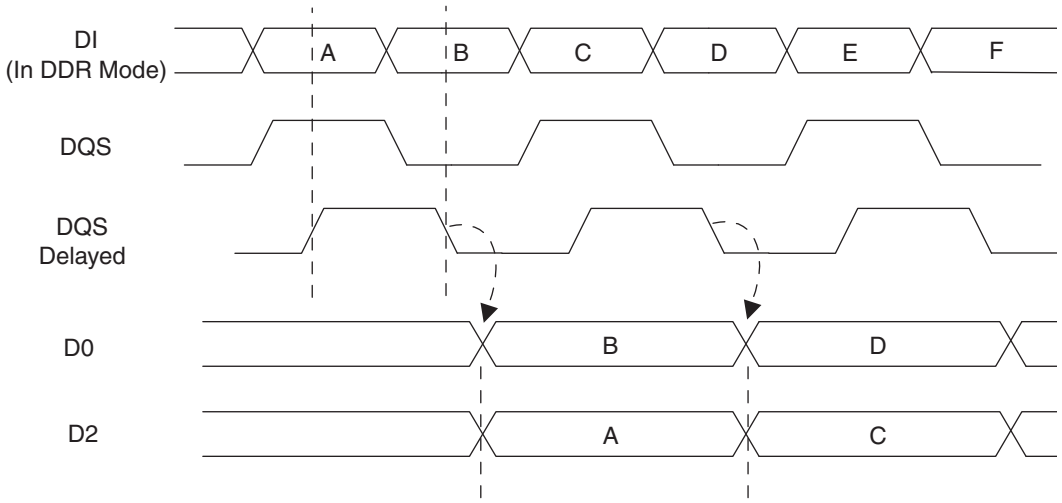
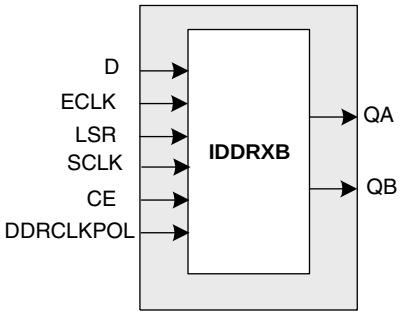


Figure 2-28. INDDRXB Primitive



Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sysI/O buffers. The block contains a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-29 shows the diagram of the Output Register Block.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured a D-type or latch. In DDR mode, ONEG0 is fed into one register on the positive edge of the clock and OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

Figure 2-30 shows the design tool DDR primitives. The SDR output register has reset and clock enable available. The additional register for DDR operation does not have reset or clock enable available.

Table 2-14. Supported Output Standards

Output Standard	Drive	V_{CCIO} (Nom.)
Single-ended Interfaces		
LVTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVCMOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVCMOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVCMOS18	4mA, 8mA, 12mA, 16mA	1.8
LVCMOS15	4mA, 8mA	1.5
LVCMOS12	2mA, 6mA	1.2
LVCMOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVCMOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVCMOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVCMOS15, Open Drain	4mA, 8mA	—
LVCMOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II, III	N/A	1.8
HSTL15 Class I, III	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I	N/A	1.8
Differential HSTL18, Class I, II, III	N/A	1.8
Differential HSTL15, Class I, III	N/A	1.5
LVDS	N/A	2.5
BLVDS[1]	N/A	2.5
LVPECL[1]	N/A	3.3
RSDS[1]	N/A	2.5

1. Emulated with external resistors.

Hot Socketing

The LatticeECP/EC devices have been carefully designed to ensure predictable behavior during power-up and power-down. Power supplies can be sequenced in any order. During power up and power-down sequences, the I/Os remain in tristate until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits, this allows for easy integration with the rest of the system. These capabilities make the LatticeECP/EC ideal for many multiple power supply and hot-swap applications.

Configuration and Testing

The following section describes the configuration and testing features of the LatticeECP/EC devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP/EC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to

be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP/EC devices contain two possible ports that can be used for device configuration. The test access port (TAP), which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration.

The TAP supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins (please refer to TN1053 for more information about using the dual-use pins as general purpose I/O). There are four configuration options for LatticeECP/EC devices:

1. Industry standard SPI memories.
2. Industry standard byte wide flash and ispMACH 4000 for control/addressing.
3. Configuration from system microprocessor via the configuration bus or TAP.
4. Industry standard FPGA board memory.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next power-up sequence.

For more information about device configuration, please see the list of technical documentation at the end of this data sheet.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeECP/EC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time.

For more information about ispTRACY, please see information regarding additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP/EC devices require a single external, 10K ohm +/- 1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

LVPECL

The LatticeECP/EC devices support differential LVPECL standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The LVPECL input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-3 is one possible solution for point-to-point signals.

Figure 3-3. Differential LVPECL

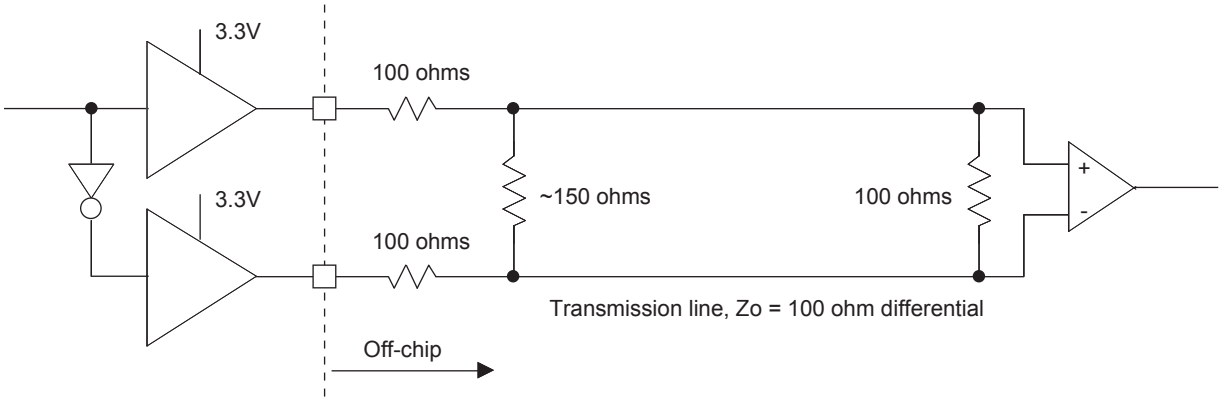


Table 3-3. LVPECL DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	100	ohm
R_P	Driver parallel resistor	150	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	2.03	V
V_{OL}	Output low voltage	1.27	V
V_{OD}	Output differential voltage	0.76	V
V_{CM}	Output common mode voltage	1.65	V
Z_{BACK}	Back impedance	85.7	ohm
I_{DC}	DC output current	12.7	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, BLVDS and other differential interfaces please see the list of technical information at the end of this data sheet.

RSDS

The LatticeECP/EC devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Use LVDS25E mode with suggested resistors for RSDS operation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Standard)

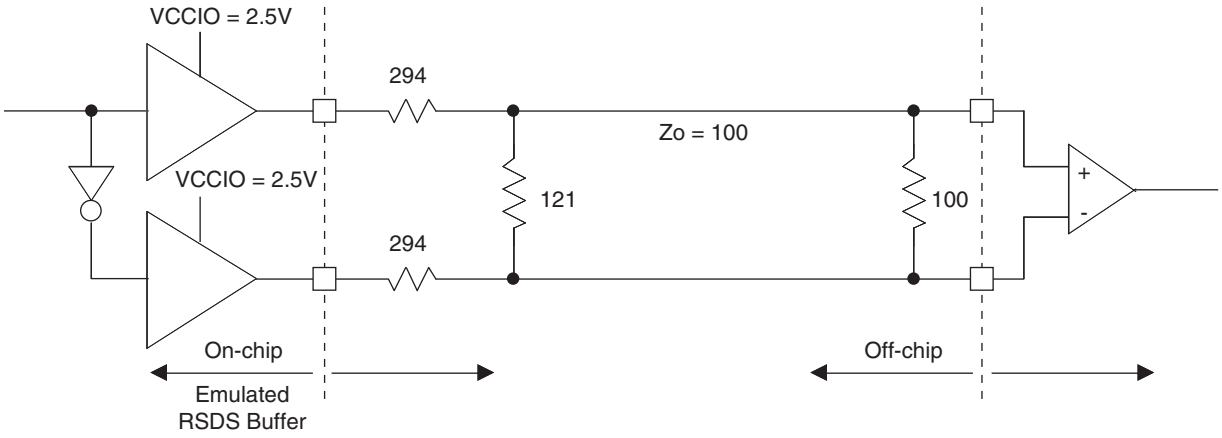


Table 3-4. RSDS DC Conditions

Parameter	Description	Typical	Units
Z_{OUT}	Output impedance	20	ohm
R_S	Driver series resistor	294	ohm
R_P	Driver parallel resistor	121	ohm
R_T	Receiver termination	100	ohm
V_{OH}	Output high voltage	1.35	V
V_{OL}	Output low voltage	1.15	V
V_{OD}	Output differential voltage	0.20	V
V_{CM}	Output common mode voltage	1.25	V
Z_{BACK}	Back impedance	101.5	ohm
I_{DC}	DC output current	3.66	mA

LatticeECP/EC Family Timing Adders[1, 2, 3] (Continued)

Over Recommended Operating Conditions

Buffer Type	Description	-5	-4	-3	Units
HSTL15_II	HSTL_15 class II	0.10	0.12	0.14	ns
HSTL15_III	HSTL_15 class III	0.10	0.12	0.14	ns
HSTL15D_I	Differential HSTL 15 class I	0.08	0.10	0.11	ns
HSTL15D_III	Differential HSTL 15 class III	0.10	0.12	0.14	ns
SSTL33_I	SSTL_3 class I	-0.05	-0.06	-0.07	ns
SSTL33_II	SSTL_3 class II	0.40	0.48	0.56	ns
SSTL33D_I	Differential SSTL_3 class I	-0.05	-0.06	-0.07	ns
SSTL33D_II	Differential SSTL_3 class II	0.40	0.48	0.56	ns
SSTL25_I	SSTL_2 class I	0.05	0.07	0.08	ns
SSTL25_II	SSTL_2 class II	0.25	0.30	0.35	ns
SSTL25D_I	Differential SSTL_2 class I	0.05	0.07	0.08	ns
SSTL25D_II	Differential SSTL_2 class II	0.25	0.30	0.35	ns
SSTL18_I	SSTL_1.8 class I	0.01	0.01	0.01	ns
SSTL18D_I	Differential SSTL_1.8 class I	0.01	0.01	0.01	ns
LVTTL33_4mA	LVTTL 4mA drive	0.09	0.11	0.13	ns
LVTTL33_8mA	LVTTL 8mA drive	0.07	0.08	0.09	ns
LVTTL33_12mA	LVTTL 12mA drive	-0.03	-0.04	-0.05	ns
LVTTL33_16mA	LVTTL 16mA drive	0.36	0.43	0.51	ns
LVTTL33_20mA	LVTTL 20mA drive	0.28	0.33	0.39	ns
LVCMOS33_4mA	LVCMOS 3.3 4mA drive	0.09	0.11	0.13	ns
LVCMOS33_8mA	LVCMOS 3.3 8mA drive	0.07	0.08	0.09	ns
LVCMOS33_12mA	LVCMOS 3.3 12mA drive	-0.03	-0.04	-0.05	ns
LVCMOS33_16mA	LVCMOS 3.3 16mA drive	0.36	0.43	0.51	ns
LVCMOS33_20mA	LVCMOS 3.3 20mA drive	0.28	0.33	0.39	ns
LVCMOS25_4mA	LVCMOS 2.5 4mA drive	0.18	0.21	0.25	ns
LVCMOS25_8mA	LVCMOS 2.5 8mA drive	0.10	0.12	0.14	ns
LVCMOS25_12mA	LVCMOS 2.5 12mA drive	0.00	0.00	0.00	ns
LVCMOS25_16mA	LVCMOS 2.5 16mA drive	0.22	0.26	0.31	ns
LVCMOS25_20mA	LVCMOS 2.5 20mA drive	0.14	0.16	0.19	ns
LVCMOS18_4mA	LVCMOS 1.8 4mA drive	0.15	0.18	0.21	ns
LVCMOS18_8mA	LVCMOS 1.8 8mA drive	0.06	0.08	0.09	ns
LVCMOS18_12mA	LVCMOS 1.8 12mA drive	0.01	0.01	0.01	ns
LVCMOS18_16mA	LVCMOS 1.8 16mA drive	0.16	0.19	0.22	ns
LVCMOS15_4mA	LVCMOS 1.5 4mA drive	0.26	0.31	0.36	ns
LVCMOS15_8mA	LVCMOS 1.5 8mA drive	0.04	0.04	0.05	ns
LVCMOS12_2mA	LVCMOS 1.2 2mA drive	0.36	0.43	0.50	ns
LVCMOS12_6mA	LVCMOS 1.2 6mA drive	0.08	0.10	0.11	ns
LVCMOS12_4mA	LVCMOS 1.2 4mA drive	0.36	0.43	0.50	ns
PCI33	PCI33	1.05	1.26	1.46	ns

1. Timing adders are characterized but not tested on every device.
2. LVCMOS timing measured with the load specified in Switching Test Conditions table of this document.
3. All other standards according to the appropriate specification.

Timing v.G 0.30

Signal Descriptions

Signal Name	I/O	Description
General Purpose		
P[Edge] [Row/Column Number*]_[A/B]	I/O	[Edge] indicates the edge of the device on which the pad is located. Valid edge designations are L (Left), B (Bottom), R (Right), T (Top). [Row/Column Number] indicates the PFU row or the column of the device on which the PIC exists. When Edge is T (Top) or (Bottom), only need to specify Row Number. When Edge is L (Left) or R (Right), only need to specify Column Number. [A/B] indicates the PIO within the PIC to which the pad is connected. Some of these user-programmable pins are shared with special function pins. These pin when not used as special purpose pins can be programmed as I/Os for user logic. During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
GSRN	I	Global RESET signal (active low). Any I/O pin can be GSRN.
NC	—	No connect.
GND	—	Ground. Dedicated pins.
V_{CC}	—	Power supply pins for core logic. Dedicated pins.
V_{CCAUX}	—	Auxiliary power supply pin. It powers all the differential and referenced input buffers. Dedicated pins.
V_{CCIOx}	—	Power supply pins for I/O bank x. Dedicated pins.
V_{REF1_x}, V_{REF2_x}	—	Reference supply pins for I/O bank x. Pre-determined pins in each bank are assigned as V_{REF} inputs. When not used, they may be used as I/O pins.
XRES	—	10K ohm +/-1% resistor must be connected between this pad and ground.
V_{CCPLL}	—	Power supply pin for PLL.þApplicable to ECP/EC33 device.
PLL and Clock Functions (Used as user programmable I/O pins when not in use for PLL or clock pins)		
[LOC][num]_PLL[T, C]_IN_A	I	Reference clock (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
[LOC][num]_PLL[T, C]_FB_A	I	Optional feedback (PLL) input pads: ULM, LLM, URM, LRM, num = row from center, T = true and C = complement, index A,B,C...at each side.
PCLK[T, C]_[n:0]_[3:0]	I	Primary Clock pads, T = true and C = complement, n per side, indexed by bank and 0,1,2,3 within bank.
[LOC]DQS[num]	I	DQS input pads: T (Top), R (Right), B (Bottom), L (Left), DQS, num = ball function number. Any pad can be configured to be output.
Test and Programming (Dedicated pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.

LFEC1, LFEC3 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC1				LFEC3			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT13A	1	T		PT21A	1	T	
170	PT12B	1	C		PT20B	1	C	
171	PT12A	1	T		PT20A	1	T	
172	PT11B	1	C	VREF2_1	PT19B	1	C	VREF2_1
173	PT11A	1	T	VREF1_1	PT19A	1	T	VREF1_1
174	PT10B	1	C		PT18B	1	C	
175	PT10A	1	T		PT18A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT9B	0	C	PCLKC0_0	PT17B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT9A	0	T	PCLKT0_0	PT17A	0	T	PCLKT0_0
181	PT8B	0	C	VREF1_0	PT16B	0	C	VREF1_0
182	PT8A	0	T	VREF2_0	PT16A	0	T	VREF2_0
183	PT7B	0	C		PT15B	0	C	
184	PT7A	0	T		PT15A	0	T	
185	PT6B	0	C		PT14B	0	C	
186	PT6A	0	T	TDQS6	PT14A	0	T	TDQS14
187	VCCIO0	0			VCCIO0	0		
188	PT5B	0	C		PT13B	0	C	
189	NC	-			GND0	0		
190	PT5A	0	T		PT13A	0	T	
191	PT4B	0	C		PT12B	0	C	
192	PT4A	0	T		PT12A	0	T	
193	PT3B	0	C		PT11B	0	C	
194	PT3A	0	T		PT11A	0	T	
195	PT2B	0	C		PT10B	0	C	
196	PT2A	0	T		PT10A	0	T	
197	NC	-			VCCIO0	0		
198	NC	-			PT6B	0	C	
199	NC	-			PT6A	0	T	TDQS6
200	NC	-			PT5B	0	C	
201	NC	-			PT5A	0	T	
202	NC	-			PT4B	0	C	
203	NC	-			PT4A	0	T	
204	NC	-			PT3B	0	C	
205	NC	-			PT3A	0	T	
206	NC	-			PT2B	0	C	
207	NC	-			PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

* Double bonded to the pin.

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND7	7		
D4	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
D3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
C3	PL3A	7	T		PL3A	7	T	
C2	PL3B	7	C		PL3B	7	C	
B1	PL4A	7	T		PL4A	7	T	
C1	PL4B	7	C		PL4B	7	C	
E3	PL5A	7	T		PL5A	7	T	
E4	PL5B	7	C		PL5B	7	C	
F4	PL6A	7	T	LDQS6	PL6A	7	T	LDQS6
F5	PL6B	7	C		PL6B	7	C	
G4	PL7A	7	T		PL7A	7	T	
G3	PL7B	7	C		PL7B	7	C	
D2	PL8A	7	T		PL8A	7	T	
D1	PL8B	7	C		PL8B	7	C	
E1	PL9A	7	T	PCLKT7_0	PL9A	7	T	PCLKT7_0
GND	GND7	7			GND7	7		
E2	PL9B	7	C	PCLKC7_0	PL9B	7	C	PCLKC7_0
F3	XRES	6			XRES	6		
G5	NC	-			PL11A	6	T	
H5	NC	-			PL11B	6	C	
F2	NC	-			PL12A	6	T	
F1	NC	-			PL12B	6	C	
H4	NC	-			PL13A	6	T	
H3	NC	-			PL13B	6	C	
G2	NC	-			PL14A	6	T	
-	-	-			GND6	6		
G1	NC	-			PL14B	6	C	
J4	NC	-			PL15A	6	T	LDQS15
J3	NC	-			PL15B	6	C	
J5	NC	-			PL16A	6	T	
K5	NC	-			PL16B	6	C	
H2	NC	-			PL17A	6	T	
H1	NC	-			PL17B	6	C	
J2	NC	-			PL18A	6	T	
-	-	-			GND6	6		
J1	NC	-			PL18B	6	C	
K4	TCK	6			TCK	6		
K3	TDI	6			TDI	6		
L3	TMS	6			TMS	6		
L5	TDO	6			TDO	6		
L4	VCCJ	6			VCCJ	6		

LFEC3 and LFECP/EC6 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFEC3				LFECP6/LFEC6			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
E5	VCC	-			VCC	-		
E8	VCC	-			VCC	-		
M12	VCC	-			VCC	-		
M5	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
B15	VCCAUX	-			VCCAUX	-		
R2	VCCAUX	-			VCCAUX	-		
F7	VCCIO0	0			VCCIO0	0		
F8	VCCIO0	0			VCCIO0	0		
F10	VCCIO1	1			VCCIO1	1		
F9	VCCIO1	1			VCCIO1	1		
G11	VCCIO2	2			VCCIO2	2		
H11	VCCIO2	2			VCCIO2	2		
J11	VCCIO3	3			VCCIO3	3		
K11	VCCIO3	3			VCCIO3	3		
L10	VCCIO4	4			VCCIO4	4		
L9	VCCIO4	4			VCCIO4	4		
L7	VCCIO5	5			VCCIO5	5		
L8	VCCIO5	5			VCCIO5	5		
J6	VCCIO6	6			VCCIO6	6		
K6	VCCIO6	6			VCCIO6	6		
G6	VCCIO7	7			VCCIO7	7		
H6	VCCIO7	7			VCCIO7	7		
F6	VCC	-			VCC	-		
F11	VCC	-			VCC	-		
L11	VCC	-			VCC	-		
L6	VCC	-			VCC	-		

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND7	7		
D4	PL2A	7	T	VREF2_7	PL2A	7	T	VREF2_7
D3	PL2B	7	C	VREF1_7	PL2B	7	C	VREF1_7
GND	GND7	7			GND7	7		
C3	PL12A	7	T		PL16A	7	T	
C2	PL12B	7	C		PL16B	7	C	
B1	PL13A	7	T		PL17A	7	T	
C1	PL13B	7	C		PL17B	7	C	
E3	PL14A	7	T		PL18A	7	T	
GND	GND7	7			GND7	7		
-	-	-			GND7	7		
E4	PL14B	7	C		PL18B	7	C	
F4	PL15A	7	T	LDQS15	PL19A	7	T	LDQS19
F5	PL15B	7	C		PL19B	7	C	
G4	PL16A	7	T		PL20A	7	T	
G3	PL16B	7	C		PL20B	7	C	
D2	PL17A	7	T		PL21A	7	T	
D1	PL17B	7	C		PL21B	7	C	
E1	PL18A	7	T	PCLKT7_0	PL22A	7	T	PCLKT7_0
GND	GND7	7			GND7	7		
E2	PL18B	7	C	PCLKC7_0	PL22B	7	C	PCLKC7_0
F3	XRES	6			XRES	6		
G5	PL20A	6	T		PL24A	6	T	
H5	PL20B	6	C		PL24B	6	C	
F2	PL21A	6	T		PL25A	6	T	
F1	PL21B	6	C		PL25B	6	C	
H4	PL22A	6	T		PL26A	6	T	
H3	PL22B	6	C		PL26B	6	C	
G2	PL23A	6	T		PL27A	6	T	
GND	GND6	6			GND6	6		
G1	PL23B	6	C		PL27B	6	C	
J4	PL24A	6	T	LDQS24	PL28A	6	T	LDQS28
J3	PL24B	6	C		PL28B	6	C	
J5	PL25A	6	T		PL29A	6	T	
K5	PL25B	6	C		PL29B	6	C	
H2	PL26A	6	T		PL30A	6	T	
H1	PL26B	6	C		PL30B	6	C	
J2	PL27A	6	T		PL31A	6	T	
GND	GND6	6			GND6	6		
J1	PL27B	6	C		PL31B	6	C	
K4	TCK	6			TCK	6		
K3	TDI	6			TDI	6		

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
G12	PR18A	2	T	PCLKT2_0	PR22A	2	T	PCLKT2_0
G13	PR17B	2	C		PR21B	2	C	
F13	PR17A	2	T		PR21A	2	T	
F12	PR16B	2	C		PR20B	2	C	
E13	PR16A	2	T		PR20A	2	T	
D16	PR15B	2	C		PR19B	2	C	
D15	PR15A	2	T		PR19A	2	T	RDQS19
F14	PR14B	2	C		PR18B	2	C	
GND	GND2	2			GND2	2		
E14	PR14A	2	T		PR18A	2	T	
C16	PR13B	2	C		PR17B	2	C	
B16	PR13A	2	T		PR17A	2	T	
C15	PR12B	2	C		PR16B	2	C	
C14	PR12A	2	T		PR16A	2	T	
GND	GND2	2			GND2	2		
-	-	-			GND2	2		
D14	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
D13	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
GND	GND2	2			GND2	2		
GND	GND1	1			GND1	1		
GND	GND1	1			GND1	1		
-	-	-			GND1	1		
-	-	-			GND1	1		
B13	PT34B	1	C		PT34B	1	C	
C13	PT34A	1	T		PT34A	1	T	
C12	PT33B	1	C		PT33B	1	C	
GND	GND1	1			GND1	1		
D12	PT33A	1	T		PT33A	1	T	
A15	PT32B	1	C		PT32B	1	C	
B14	PT32A	1	T		PT32A	1	T	
D11	PT31B	1	C		PT31B	1	C	
C11	PT31A	1	T		PT31A	1	T	
E10	PT30B	1	C		PT30B	1	C	
E11	PT30A	1	T	TDQS30	PT30A	1	T	TDQS30
A14	PT29B	1	C		PT29B	1	C	
GND	GND1	1			GND1	1		
A13	PT29A	1	T		PT29A	1	T	
D10	PT28B	1	C		PT28B	1	C	
C10	PT28A	1	T		PT28A	1	T	
A12	PT27B	1	C	VREF2_1	PT27B	1	C	VREF2_1
B12	PT27A	1	T	VREF1_1	PT27A	1	T	VREF1_1
A11	PT26B	1	C		PT26B	1	C	
B11	PT26A	1	T		PT26A	1	T	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
GND	GND7	7			GND	GND7	7		
D4	PL2A	7	T	VREF2_7	D4	PL2A	7	T	VREF2_7
E4	PL2B	7	C	VREF1_7	E4	PL2B	7	C	VREF1_7
GND	-	-			GND	GND7	7		
C3	PL3A	7	T		C3	PL10A	7	T	
B2	PL3B	7	C		B2	PL10B	7	C	
E5	PL4A	7	T		E5	PL11A	7	T	
F5	PL4B	7	C		F5	PL11B	7	C	
D3	PL5A	7	T		D3	PL12A	7	T	
C2	PL5B	7	C		C2	PL12B	7	C	
GND	-	-			GND	GND7	7		
F4	PL6A	7	T	LDQS6	F4	PL14A	7	T	LDQS14
G4	PL6B	7	C		G4	PL14B	7	C	
E3	PL7A	7	T		E3	PL15A	7	T	
D2	PL7B	7	C		D2	PL15B	7	C	
B1	PL8A	7	T	LUM0_PLLT_IN_A	B1	PL16A	7	T	LUM0_PLLT_IN_A
C1	PL8B	7	C	LUM0_PLLC_IN_A	C1	PL16B	7	C	LUM0_PLLC_IN_A
F3	PL9A	7	T	LUM0_PLLT_FB_A	F3	PL17A	7	T	LUM0_PLLT_FB_A
GND	GND7	7			GND	GND7	7		
E2	PL9B	7	C	LUM0_PLLC_FB_A	E2	PL17B	7	C	LUM0_PLLC_FB_A
GND	-	-			GND	GND7	7		
G5	PL11A	7	T		G5	PL23A	7	T	LDQS23
H6	PL11B	7	C		H6	PL23B	7	C	
G3	PL12A	7	T		G3	PL24A	7	T	
H4	PL12B	7	C		H4	PL24B	7	C	
J5	PL13A	7	T		J5	PL25A	7	T	
H5	PL13B	7	C		H5	PL25B	7	C	
F2	PL14A	7	T		F2	PL26A	7	T	
GND	GND7	7			GND	GND7	7		
F1	PL14B	7	C		F1	PL26B	7	C	
E1	PL15A	7	T		E1	PL27A	7	T	
D1	PL15B	7	C		D1	PL27B	7	C	
H3	PL16A	7	T		H3	PL28A	7	T	
G2	PL16B	7	C		G2	PL28B	7	C	
H2	PL17A	7	T		H2	PL29A	7	T	
G1	PL17B	7	C		G1	PL29B	7	C	
J4	PL18A	7	T		J4	PL30A	7	T	
GND	GND7	7			GND	GND7	7		
J3	PL18B	7	C		J3	PL30B	7	C	
J2	PL19A	7	T	LDQS19	J2	PL31A	7	T	LDQS31
H1	PL19B	7	C		H1	PL31B	7	C	
K4	PL20A	7	T		K4	PL32A	7	T	
K5	PL20B	7	C		K5	PL32B	7	C	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A17	PT47A	1	T		A17	PT47A	1	T	
B15	PT46B	1	C		B15	PT46B	1	C	
A16	PT46A	1	T	TDQS46	A16	PT46A	1	T	TDQS46
A15	PT45B	1	C		A15	PT45B	1	C	
GND	GND1	1			GND	GND1	1		
A14	PT45A	1	T		A14	PT45A	1	T	
G14	PT44B	1	C		G14	PT44B	1	C	
E15	PT44A	1	T		E15	PT44A	1	T	
D15	PT43B	1	C		D15	PT43B	1	C	
C15	PT43A	1	T		C15	PT43A	1	T	
C14	PT42B	1	C		C14	PT42B	1	C	
B14	PT42A	1	T		B14	PT42A	1	T	
A13	PT41B	1	C		A13	PT41B	1	C	
GND	GND1	1			GND	GND1	1		
B13	PT41A	1	T		B13	PT41A	1	T	
E14	PT40B	1	C		E14	PT40B	1	C	
C13	PT40A	1	T		C13	PT40A	1	T	
F14	PT39B	1	C		F14	PT39B	1	C	
D14	PT39A	1	T		D14	PT39A	1	T	
E13	PT38B	1	C		E13	PT38B	1	C	
G13	PT38A	1	T	TDQS38	G13	PT38A	1	T	TDQS38
A12	PT37B	1	C		A12	PT37B	1	C	
GND	GND1	1			GND	GND1	1		
B12	PT37A	1	T		B12	PT37A	1	T	
F13	PT36B	1	C		F13	PT36B	1	C	
D13	PT36A	1	T		D13	PT36A	1	T	
F12	PT35B	1	C	VREF2_1	F12	PT35B	1	C	VREF2_1
D12	PT35A	1	T	VREF1_1	D12	PT35A	1	T	VREF1_1
F11	PT34B	1	C		F11	PT34B	1	C	
C12	PT34A	1	T		C12	PT34A	1	T	
A11	PT33B	0	C	PCLKC0_0	A11	PT33B	0	C	PCLKC0_0
GND	GND0	0			GND	GND0	0		
A10	PT33A	0	T	PCLKT0_0	A10	PT33A	0	T	PCLKT0_0
E12	PT32B	0	C	VREF1_0	E12	PT32B	0	C	VREF1_0
E11	PT32A	0	T	VREF2_0	E11	PT32A	0	T	VREF2_0
B11	PT31B	0	C		B11	PT31B	0	C	
C11	PT31A	0	T		C11	PT31A	0	T	
B9	PT30B	0	C		B9	PT30B	0	C	
B10	PT30A	0	T	TDQS30	B10	PT30A	0	T	TDQS30
A9	PT29B	0	C		A9	PT29B	0	C	
GND	GND0	0			GND	GND0	0		
A8	PT29A	0	T		A8	PT29A	0	T	
D11	PT28B	0	C		D11	PT28B	0	C	
C10	PT28A	0	T		C10	PT28A	0	T	

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
K16	VCC	-			K16	VCC	-		
K17	VCC	-			K17	VCC	-		
K6	VCC	-			K6	VCC	-		
K7	VCC	-			K7	VCC	-		
L17	VCC	-			L17	VCC	-		
L6	VCC	-			L6	VCC	-		
M17	VCC	-			M17	VCC	-		
M6	VCC	-			M6	VCC	-		
N16	VCC	-			N16	VCC	-		
N17	VCC	-			N17	VCC	-		
N6	VCC	-			N6	VCC	-		
N7	VCC	-			N7	VCC	-		
P16	VCC	-			P16	VCC	-		
P7	VCC	-			P7	VCC	-		
G11	VCCIO0	0			G11	VCCIO0	0		
H10	VCCIO0	0			H10	VCCIO0	0		
H11	VCCIO0	0			H11	VCCIO0	0		
H9	VCCIO0	0			H9	VCCIO0	0		
G12	VCCIO1	1			G12	VCCIO1	1		
H12	VCCIO1	1			H12	VCCIO1	1		
H13	VCCIO1	1			H13	VCCIO1	1		
H14	VCCIO1	1			H14	VCCIO1	1		
J15	VCCIO2	2			J15	VCCIO2	2		
K15	VCCIO2	2			K15	VCCIO2	2		
L15	VCCIO2	2			L15	VCCIO2	2		
L16	VCCIO2	2			L16	VCCIO2	2		
M15	VCCIO3	3			M15	VCCIO3	3		
M16	VCCIO3	3			M16	VCCIO3	3		
N15	VCCIO3	3			N15	VCCIO3	3		
P15	VCCIO3	3			P15	VCCIO3	3		
R12	VCCIO4	4			R12	VCCIO4	4		
R13	VCCIO4	4			R13	VCCIO4	4		
R14	VCCIO4	4			R14	VCCIO4	4		
T12	VCCIO4	4			T12	VCCIO4	4		
R10	VCCIO5	5			R10	VCCIO5	5		
R11	VCCIO5	5			R11	VCCIO5	5		
R9	VCCIO5	5			R9	VCCIO5	5		
T11	VCCIO5	5			T11	VCCIO5	5		
M7	VCCIO6	6			M7	VCCIO6	6		
M8	VCCIO6	6			M8	VCCIO6	6		
N8	VCCIO6	6			N8	VCCIO6	6		
P8	VCCIO6	6			P8	VCCIO6	6		
J8	VCCIO7	7			J8	VCCIO7	7		
K8	VCCIO7	7			K8	VCCIO7	7		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
U12	GND	-			U12	GND	-		
U13	GND	-			U13	GND	-		
U14	GND	-			U14	GND	-		
U15	GND	-			U15	GND	-		
U16	GND	-			U16	GND	-		
U17	GND	-			U17	GND	-		
H10	VCC	-			H10	VCC	-		
H11	VCC	-			H11	VCC	-		
H16	VCC	-			H16	VCC	-		
H17	VCC	-			H17	VCC	-		
H18	VCC	-			H18	VCC	-		
H19	VCC	-			H19	VCC	-		
H8	VCC	-			H8	VCC	-		
H9	VCC	-			H9	VCC	-		
J18	VCC	-			J18	VCC	-		
J9	VCC	-			J9	VCC	-		
K8	VCC	-			K8	VCC	-		
L19	VCC	-			L19	VCC	-		
M19	VCC	-			M19	VCC	-		
N7	VCC	-			N7	VCC	-		
R20	VCC	-			R20	VCC	-		
R7	VCC	-			R7	VCC	-		
T19	VCC	-			T19	VCC	-		
V18	VCC	-			V18	VCC	-		
V8	VCC	-			V8	VCC	-		
V9	VCC	-			V9	VCC	-		
W10	VCC	-			W10	VCC	-		
W11	VCC	-			W11	VCC	-		
W16	VCC	-			W16	VCC	-		
W17	VCC	-			W17	VCC	-		
W18	VCC	-			W18	VCC	-		
W19	VCC	-			W19	VCC	-		
W8	VCC	-			W8	VCC	-		
W9	VCC	-			W9	VCC	-		
H12	VCCIO0	0			H12	VCCIO0	0		
H13	VCCIO0	0			H13	VCCIO0	0		
J10	VCCIO0	0			J10	VCCIO0	0		
J11	VCCIO0	0			J11	VCCIO0	0		
J12	VCCIO0	0			J12	VCCIO0	0		
J13	VCCIO0	0			J13	VCCIO0	0		
H14	VCCIO1	1			H14	VCCIO1	1		
H15	VCCIO1	1			H15	VCCIO1	1		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
H7	VCCAUX	-			H7	VCCAUX	-		
J19	VCCAUX	-			J19	VCCAUX	-		
J8	VCCAUX	-			J8	VCCAUX	-		
K7	VCCAUX	-			K7	VCCAUX	-		
L20	VCCAUX	-			L20	VCCAUX	-		
M20	VCCAUX	-			M20	VCCAUX	-		
M7	VCCAUX	-			M7	VCCAUX	-		
N20	VCCAUX	-			N20	VCCAUX	-		
P20	VCCAUX	-			P20	VCCAUX	-		
P7	VCCAUX	-			P7	VCCAUX	-		
T20	VCCAUX	-			T20	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-		
V19	VCCAUX	-			V19	VCCAUX	-		
V7	VCCAUX	-			V7	VCCAUX	-		
W20	VCCAUX	-			W20	VCCAUX	-		
Y13	VCCAUX	-			Y13	VCCAUX	-		
Y7	VCCAUX	-			Y7	VCCAUX	-		
K19	VCC[1]	-			K19	VCCPLL	-		
L8	VCC[1]	-			L8	VCCPLL	-		
U19	VCC[1]	-			U19	VCCPLL	-		
U8	VCC[1]	-			U8	VCCPLL	-		

1. Tied to V_{CCPLL}.

Date	Version	Section	Change Summary
December 2004	01.4	Architecture	Updated Hot Socketing Recommended Power Up Sequence section.
		Pinout Information	Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Pin Information
			Added LFEC1, LFEC3, LFECP/EC10, LFECP/EC15 to Power Supply and NC Connections
			Added LFEC1 and LFEC3 100 TQFP Pinout
			Added LFEC1 and LFEC3 144 TQFP Pinout
			Added LFEC1, LFEC3 and LFECP/EC10 208 PQFP Pinout
			Added LFEC3, LFECP/EC10 and LFECP/EC15 256 fpBGA Pinout
			Added LFECP/EC10 and LFECP/EC15 484 fpBGA Pinout
		Ordering Information	Added Lead-Free Package Designators
			Added Lead-Free Ordering Part Numbers
		Supplemental Information	Updated list of technical notes.
April 2005	01.5	Architecture	EBR memory support section has been updated with clarification.
			Updated sysIO buffer pair section.
		DC & Switching Characteristics	Hot Socketing Specification has been updated.
			DC Electrical Characteristics table (I_{IL}, I_{IH}) has been updated.
			Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			External Switching Characteristics section has been updated.
			Removed t_{RSTW} spec. from PLL Parameter table.
			t_{RST} specifications have been updated.
			sysCONFIG Port Timing Specifications (t_{BSCL}, t_{IODISS}, t_{PRGMRJ}) have been updated.
		Pinout Information	Added LFECP/EC33 Pinout Information
			Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
			484-fpBGA logic connection has been updated (Ball # J6, J17, P6 and P17 for ECP/EC33 are now called VCCPLL).
			672-fpBGA logic connection has been updated (Ball # K19, L8, U19, U8 for ECP/EC33 are now called VCCPLL).
May 2005	01.6	Introduction	ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.
		Architecture	Table 2-10 has been updated (ECP/EC33 EBR SRAM Bits and Blocks have been updated to 498K and 54 respectively.)
			Recommended Power Up Sequence section has been removed.
		DC & Switching Characteristics	Supply Current (Standby) table has been updated.
			Initialization Supply Current table has been updated.
			Vos test condition has been updated to (VOP+VOM)/2.
			Register-to-Register performance table has been updated (rev. G 0.27).
			External switching characteristics have been updated (rev. G 0.27).
			Internal timing parameters have been updated (rev. G 0.27).
			Timing adders have been updated (rev. G 0.27).
			sysCONFIG port timing specifications have been updated.
		Pinout Information	Pin Information Summary table has been updated.
			Power Supply and NC Connection table has been updated.
		Ordering Information	OPN list has been updated.